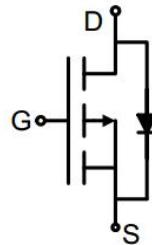


## P-Channel Enhancement Mode Power MOSFET

### Description

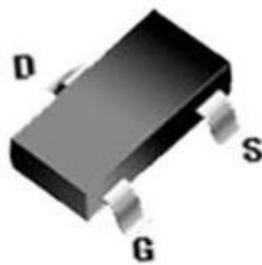
The G02P06 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge. It can be used in a wide variety of applications.



Schematic diagram

### General Features

- $V_{DS}$  -60V
- $I_D$  (at  $V_{GS} = -10V$ ) -1.6A
- $R_{DS(ON)}$  (at  $V_{GS} = -10V$ ) < 190mΩ
- $R_{DS(ON)}$  (at  $V_{GS} = -4.5V$ ) < 230mΩ
- 100% Avalanche Tested
- RoHS Compliant



SOT-23

### Application

- Power switch
- DC/DC converters

### Ordering Information

Device	Package	Marking	Packaging
G02P06	SOT-23	G02P06	3000pcs/Reel

### Absolute Maximum Ratings $T_C = 25^\circ C$ , unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-60	V
Continuous Drain Current	$I_D$	-1.6	A
Pulsed Drain Current (note1)	$I_{DM}$	-6.4	A
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Power Dissipation	$P_D$	1.5	W
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 To 150	°C

### Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	$R_{thJA}$	83	°C/W

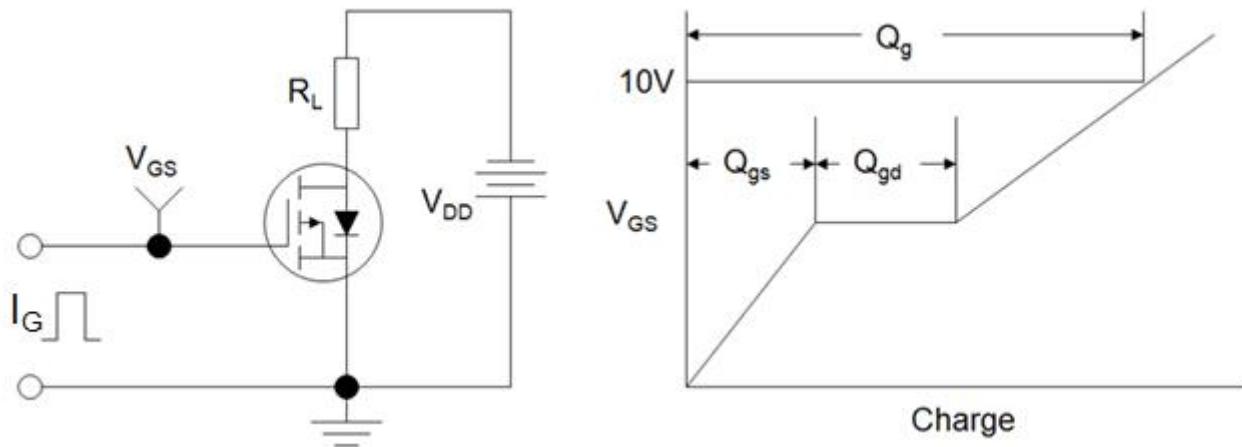
**Specifications**  $T_J = 25^\circ\text{C}$ , unless otherwise noted<sup>30</sup>

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-60	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = -60\text{V}, V_{\text{GS}} = 0\text{V}$	--	--	-1	$\mu\text{A}$
Gate-Source Leakage	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 20\text{V}$	--	--	$\pm 100$	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-1.2	-1.8	-2.5	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_D = -1\text{A}$	--	150	190	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -1\text{A}$	--	180	230	
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = -5\text{V}, I_D = -1\text{A}$	--	3.6	--	S
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = -30\text{V}, f = 1.0\text{MHz}$	--	566	--	$\text{pF}$
Output Capacitance	$C_{\text{oss}}$		--	26	--	
Reverse Transfer Capacitance	$C_{\text{rss}}$		--	23	--	
Total Gate Charge	$Q_g$	$V_{\text{DD}} = -30\text{V}, I_D = -1\text{A}, V_{\text{GS}} = -10\text{V}$	--	11.3	--	$\text{nC}$
Gate-Source Charge	$Q_{\text{gs}}$		--	2.7	--	
Gate-Drain Charge	$Q_{\text{gd}}$		--	1.6	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -30\text{V}, I_D = -1\text{A}, R_G = 3\Omega$	--	40	--	$\text{ns}$
Turn-on Rise Time	$t_r$		--	35	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	15	--	
Turn-off Fall Time	$t_f$		--	10	--	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$	$T_C = 25^\circ\text{C}$	--	--	-1.6	A
Body Diode Voltage	$V_{\text{SD}}$	$T_J = 25^\circ\text{C}, I_{\text{SD}} = -1\text{A}, V_{\text{GS}} = 0\text{V}$	--	--	-1.2	V
Reverse Recovery Charge	$Q_{\text{rr}}$	$I_F = -1\text{A}, V_{\text{GS}} = 0\text{V}$ $dI/dt = -100\text{A}/\mu\text{s}$	--	31	--	$\text{nC}$
Reverse Recovery Time	$T_{\text{rr}}$		--	25	--	ns

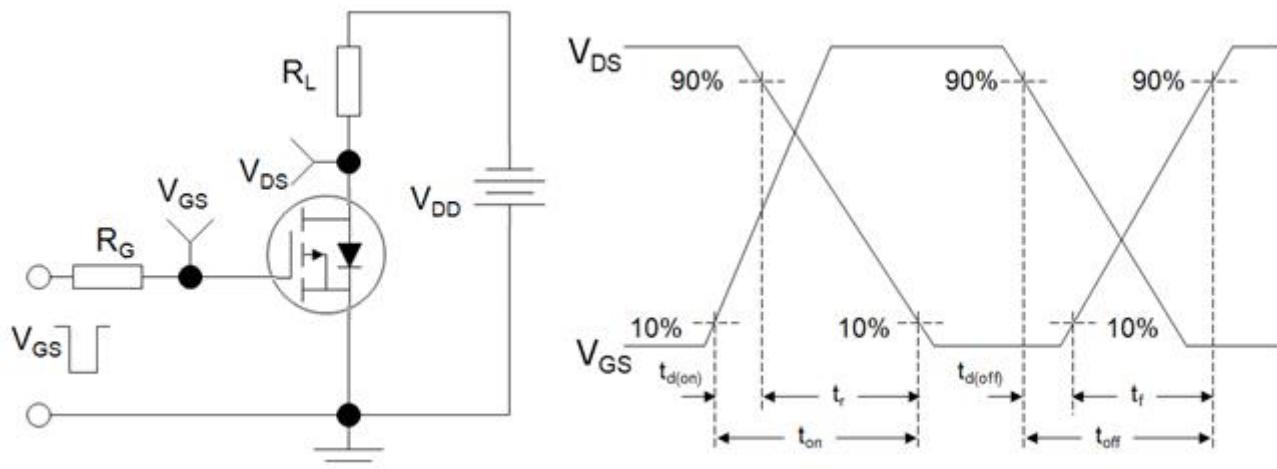
**Notes**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical  $R_G$

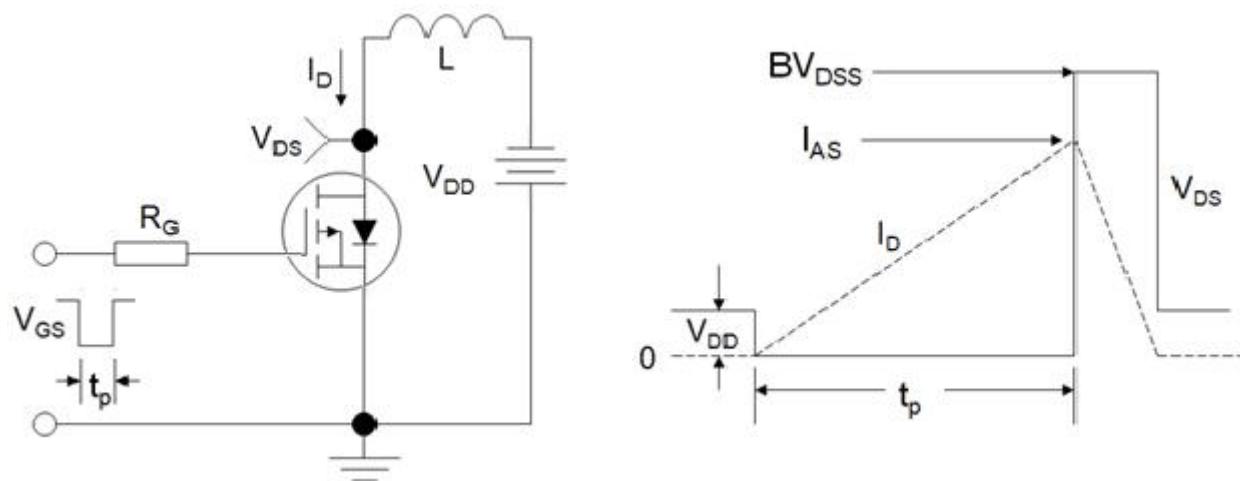
Gate Charge Test Circuit



Switch Time Test Circuit

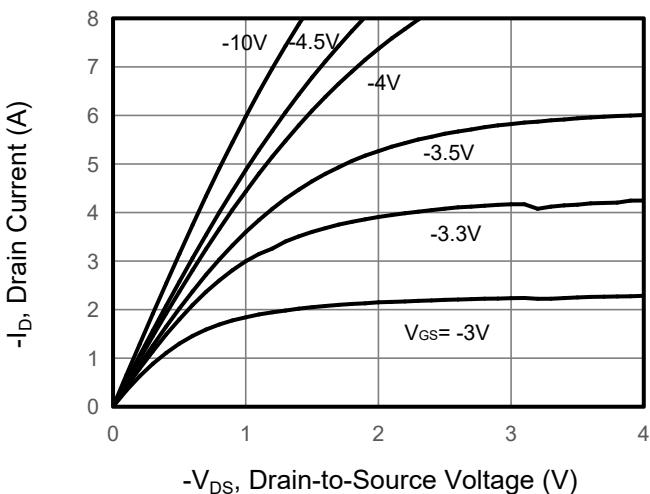


EAS Test Circuit

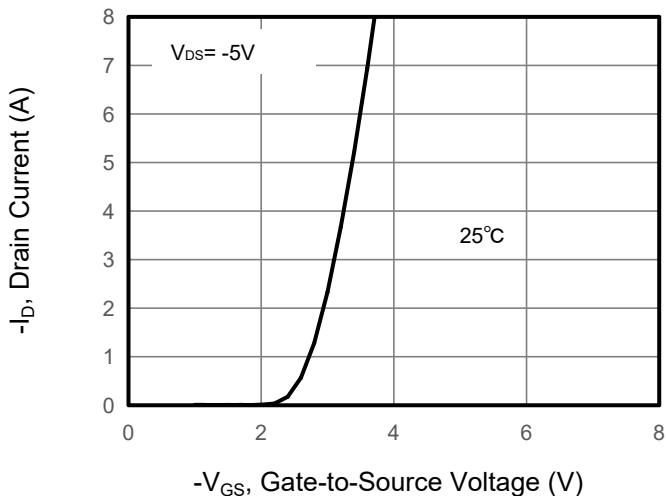


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

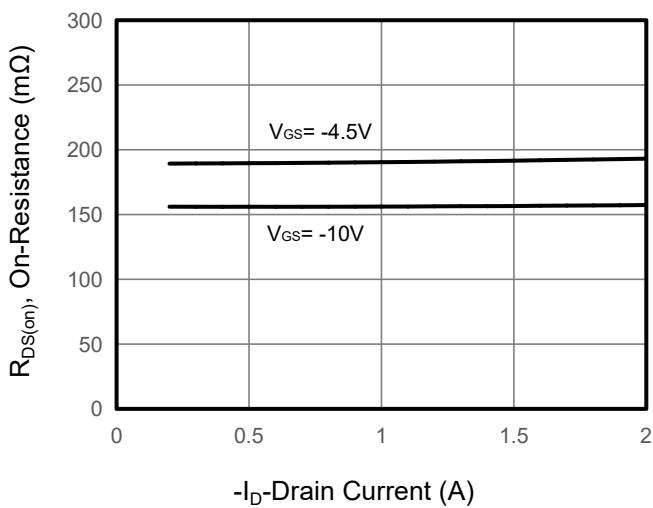
**Figure 1. Output Characteristics**



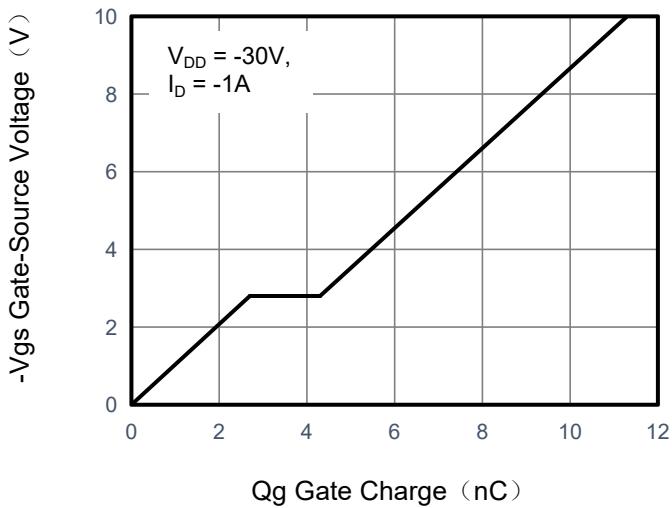
**Figure 2. Transfer Characteristics**



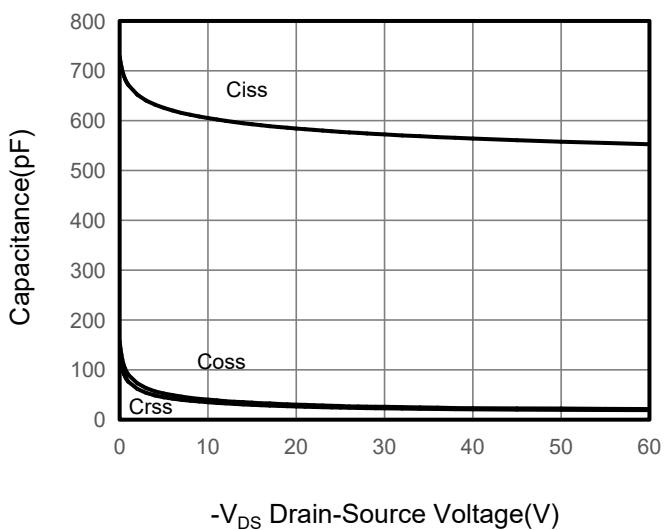
**Figure 3. Drain Source On Resistance**



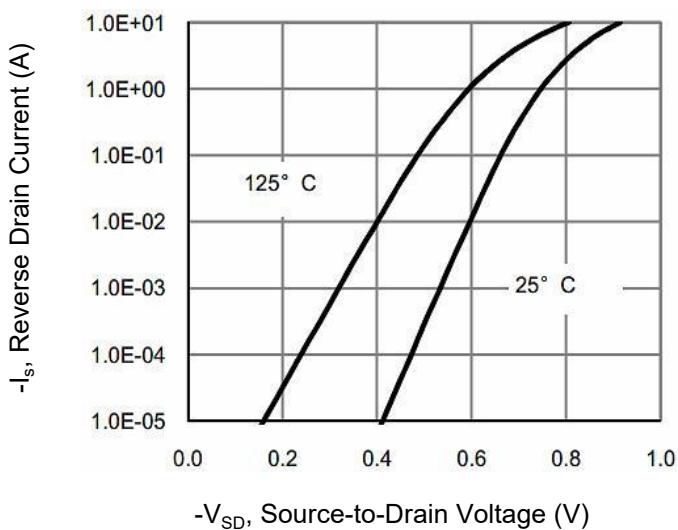
**Figure 4. Gate Charge**



**Figure 5. Capacitance**

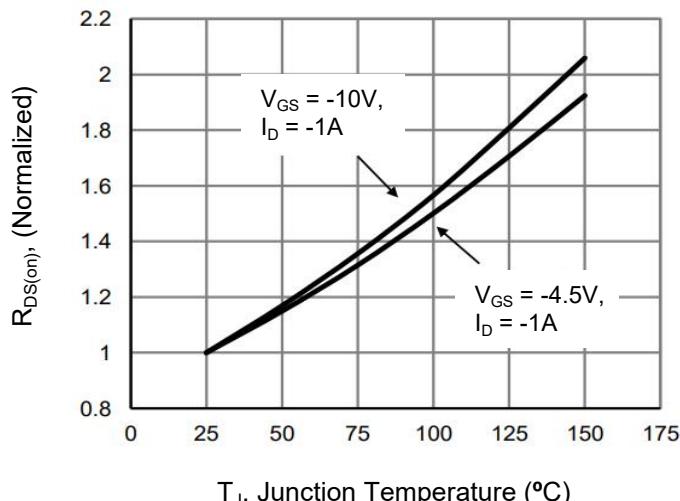


**Figure 6. Source-Drain Diode Forward**

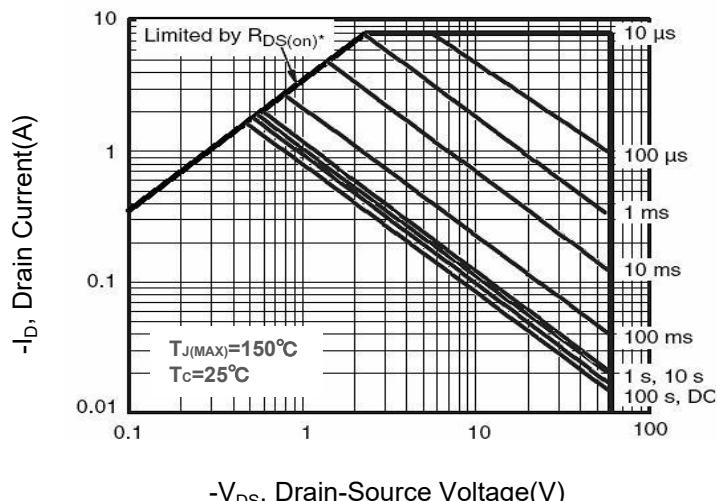


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

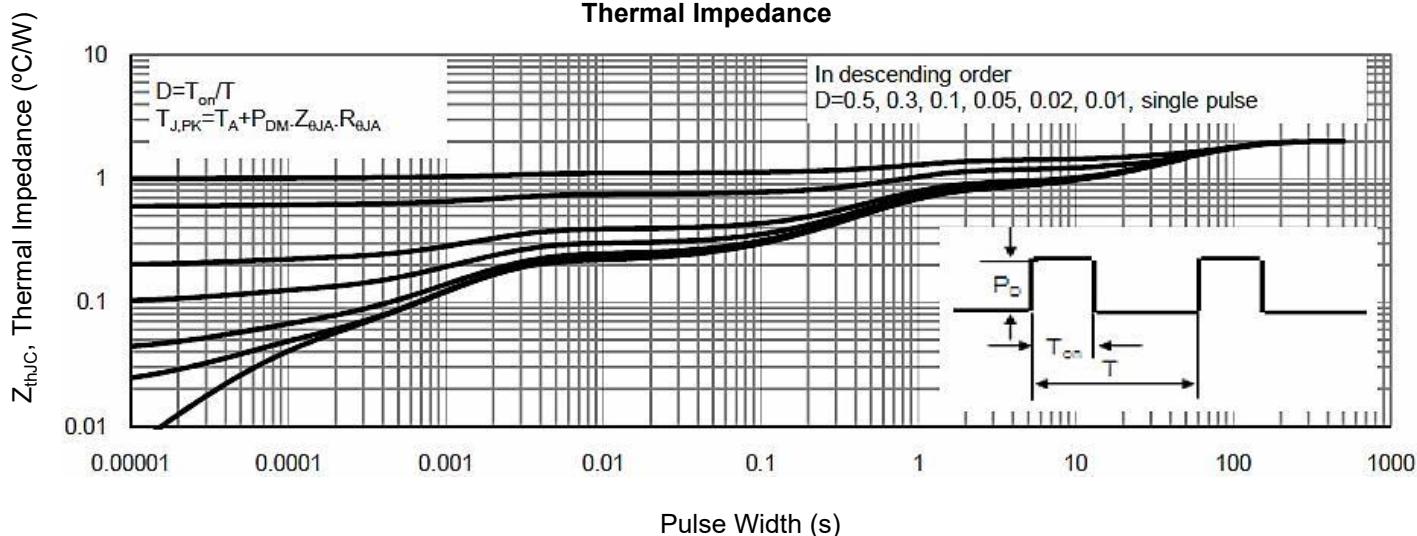
**Figure 7. Drain-Source On-Resistance**

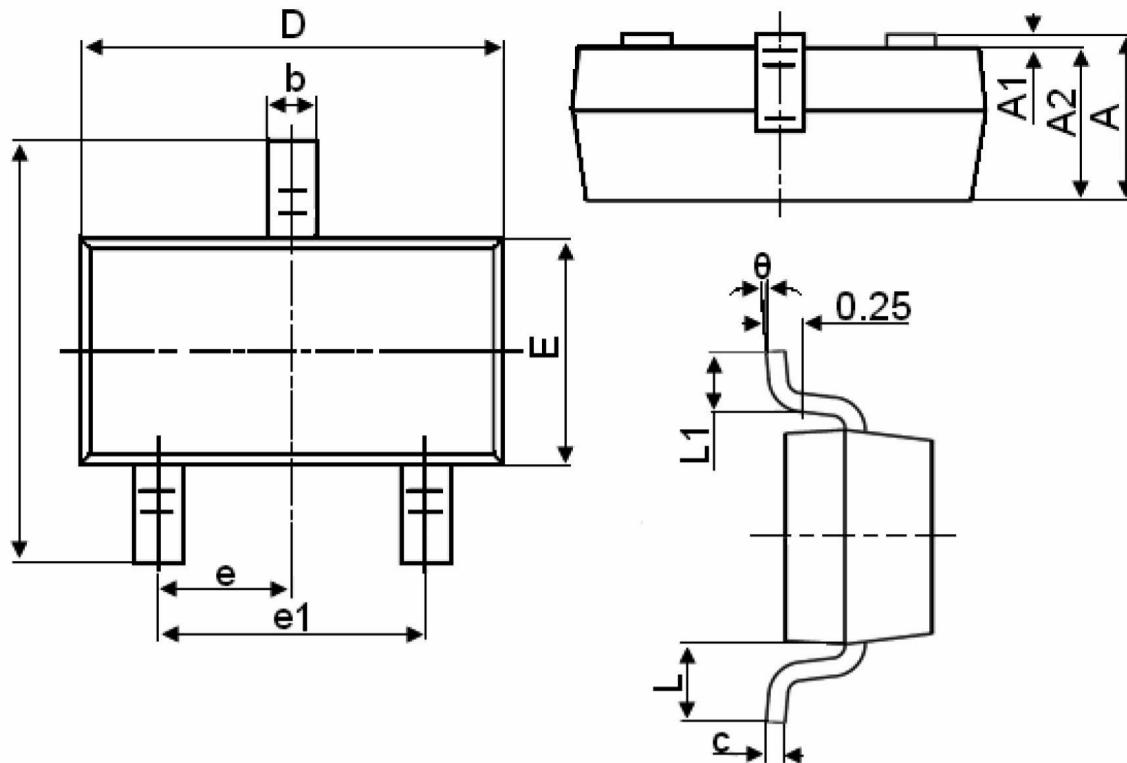


**Figure 10. Safe Operation Area**



**Figure 9. Normalized Maximum Transient Thermal Impedance**



**SOT-23 Package Information**

Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.500
θ	0°	8°